



IN THE
UNITED STATES PATENT AND TRADEMARK OFFICE

SAH
HTSA
S-1100

APPLICANTS: Steven F. Reiber et al.
SERIAL NO.: 09/514,454
FILING DATE: February 25, 2000
TITLE: Dissipative Ceramic Bonding Tip
ATTY.DKT.NO.: PA1118US

CERTIFICATE OF MAILING

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Date: May 30, 2000

David Lewis
David Lewis

PRELIMINARY AMENDMENT

Sir;

Please amend the specification as follows:

In the specification:

On page 1, line 10, insert --

CROSS REFERENCE TO RELATED APPLICATIONS

This application claims benefits of Provisional Application S.N. 60/121,694, filed February 25, 1999, entitled Dissipative Ceramic Bonding Tip. --

Line 11, delete "1."

Line 17 delete "2."

Respectfully submitted,
Steven F. Reiber et al.

Date: May 30, 2000

By:

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